

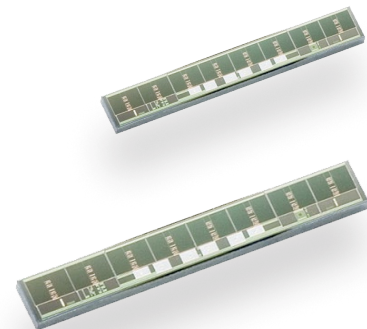
AL797

MagnetoResistive FixPitch Sensor (2.5 mm)

The AL797 is an AnisotropicMagnetoResistive (AMR) position sensor. The sensor contains two Wheatstone bridges shifted against each other. The output signals are proportional to sine and cosine of the coordinate to be measured (see Fig.2).

The MR strips of this FixPitch sensor geometrically match to a pole length of 2.5 mm (equal to a magnetic period of 5 mm). Additionally, the sensor layout incorporates PerfectWave technology, i. e. the position of each block of MR strips has a special arrangement to filter higher harmonics and to increase the signal quality. The resistances in this PurePitch sensor are distributed over several poles (2), thus the errors in the measurement scale are reduced without any signal delay. The amplitude is almost constant in a wide working range between sensor and magnetic scale.

The bond version of AL797 is available as bare die. For SMD processing, the sensor is available in a SIL6 or LGA package.



Product Overview of AL797

Article description	Package	Delivery type
AL797ACA-AA	Bare die	Wafer pack (108)
AL797ACA-AB	Die on wafer ¹⁾	Waferbox
AL797AKA-AC	SIL6	Wafer pack (90)
AL797AMA-AE	LGA6L	Tape on reel (2500)

¹⁾ Minimum order quantities apply.

Quick Reference Guide

Symbol	Parameter	Min.	Typ.	Max.	Unit
P	Pitch (magnetic pole length)	-	2.5	-	mm
V _{CC}	Supply voltage	-	5.0	-	V
V _{off}	Offset voltage per V _{CC}	-1.0	-	+1.0	mV/V
V _{peak}	Signal amplitude per V _{CC}	9.0	11.0	13.0	mV/V
R _B	Bridge resistance	4.9	5.4	5.9	kΩ

Absolute Maximum Ratings

In accordance with the absolute maximum rating system (IEC60134).

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply voltage	-9.0	+9.0	V
T _{amb}	Ambient temperature	-40	+125	°C
T _{stg}	Storage temperature	-65	+150	°C

Stresses beyond those listed under "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Features

- Based on the AnisotropicMagnetoResistive (AMR) effect
- Contains two Wheatstone bridges on Chip
- Sine and Cosine output
- Adapted to 2.5 mm poles
- PurePitch design (2 poles)
- PerfectWave technology
- Ambient temperature range from -40 °C to +125 °C

Advantages

- Contactless angle and position measurement
- Large air gap
- Excellent accuracy
- Minimized offset voltage
- Negligible hysteresis

Applications

Incremental or absolute encoder for linear or rotary movements in various industrial applications, for example:

- Motor integrated encoder
- Motorfeedback system



Magnetic Data

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
H_{ext}	Magnetic field strength ¹⁾		15.0	25.0	-	kA/m

¹⁾ The stimulating magnetic field in the sensor plane to ensure minimum error specified in note 8.

Electrical Data

$T_{amb} = 25\text{ °C}$; $H_{ext} = 25\text{ kA/m}$; $V_{CC} = 5\text{ V}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage		-	5.0	-	V
V_{off}	Offset voltage per V_{CC}	See Fig.2	-1.0	-	+1.0	mV/V
TC_{Voff}	Temperature coefficient of V_{off} ²⁾	$T_{amb} = (-40\dots+125)\text{ °C}$	-2.0	-	+2.0	($\mu\text{V/V}$)/K
V_{peak}	Signal amplitude per V_{CC} ³⁾	See Fig.2	9.0	11.0	13.0	mV/V
TC_{Vpeak}	Temperature coefficient of V_{peak} ⁴⁾	$T_{amb} = (-40\dots+125)\text{ °C}$	-0.48	-0.42	-0.36	%/K
R_B	Bridge resistance ⁵⁾		4.9	5.4	5.9	k Ω
R_S	Sensor resistance ⁶⁾		2.45	2.7	2.95	k Ω
TC_{RB}	Temperature coefficient of R_B ⁷⁾	$T_{amb} = (-40\dots+125)\text{ °C}$	0.24	0.28	0.32	%/K

$$^2) TC_{Voff} = \frac{V_{off(T_2)} - V_{off(T_1)}}{T_2 - T_1} \text{ with } T_1 = +25\text{ °C}; T_2 = +125\text{ °C}.$$

³⁾ Maximal output voltage without offset influences. Periodicity of V_{peak} is $\sin(P)$ and $\cos(P)$.

$$^4) TC_{Vpeak} = 100 \cdot \frac{V_{peak(T_2)} - V_{peak(T_1)}}{V_{peak(T_1)} \cdot (T_2 - T_1)} \text{ with } T_1 = +25\text{ °C}; T_2 = +125\text{ °C}.$$

⁵⁾ Bridge resistance between $+V_{O1}$ and $-V_{O1}$, $+V_{O2}$ and $-V_{O2}$.

⁶⁾ Sensor resistance between V_{CC} and GND.

$$^7) TC_{RB} = 100 \cdot \frac{R_{B(T_2)} - R_{B(T_1)}}{R_{B(T_1)} \cdot (T_2 - T_1)} \text{ with } T_1 = +25\text{ °C}; T_2 = +125\text{ °C}.$$

Accuracy

$T_{amb} = 25\text{ °C}$; $H_{ext} = 25\text{ kA/m}$; $V_{CC} = 5\text{ V}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
ΔX	Measurement error ⁸⁾		-	15.0	25.0	μm
k	Amplitude synchronism ⁹⁾		-	0.1	1	% of V_{peak}

⁸⁾ $\Delta X = |x_{real} - x_{measured}|$ without offset influences due to deviations from ideal sinusoidal characteristics.

$$^9) k = 100 - 100 \cdot \frac{V_{peak1}}{V_{peak2}}$$

Dynamic Data

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
f	Frequency range		1 ¹⁰⁾	-	-	MHz

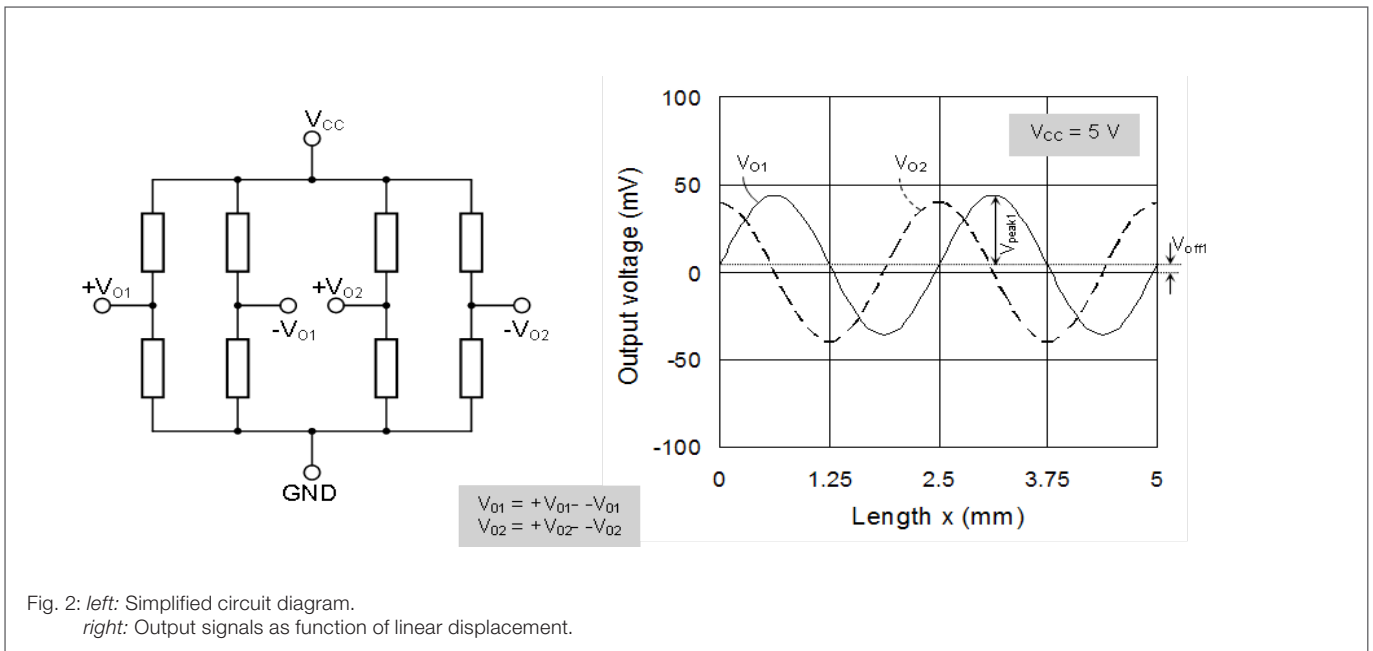
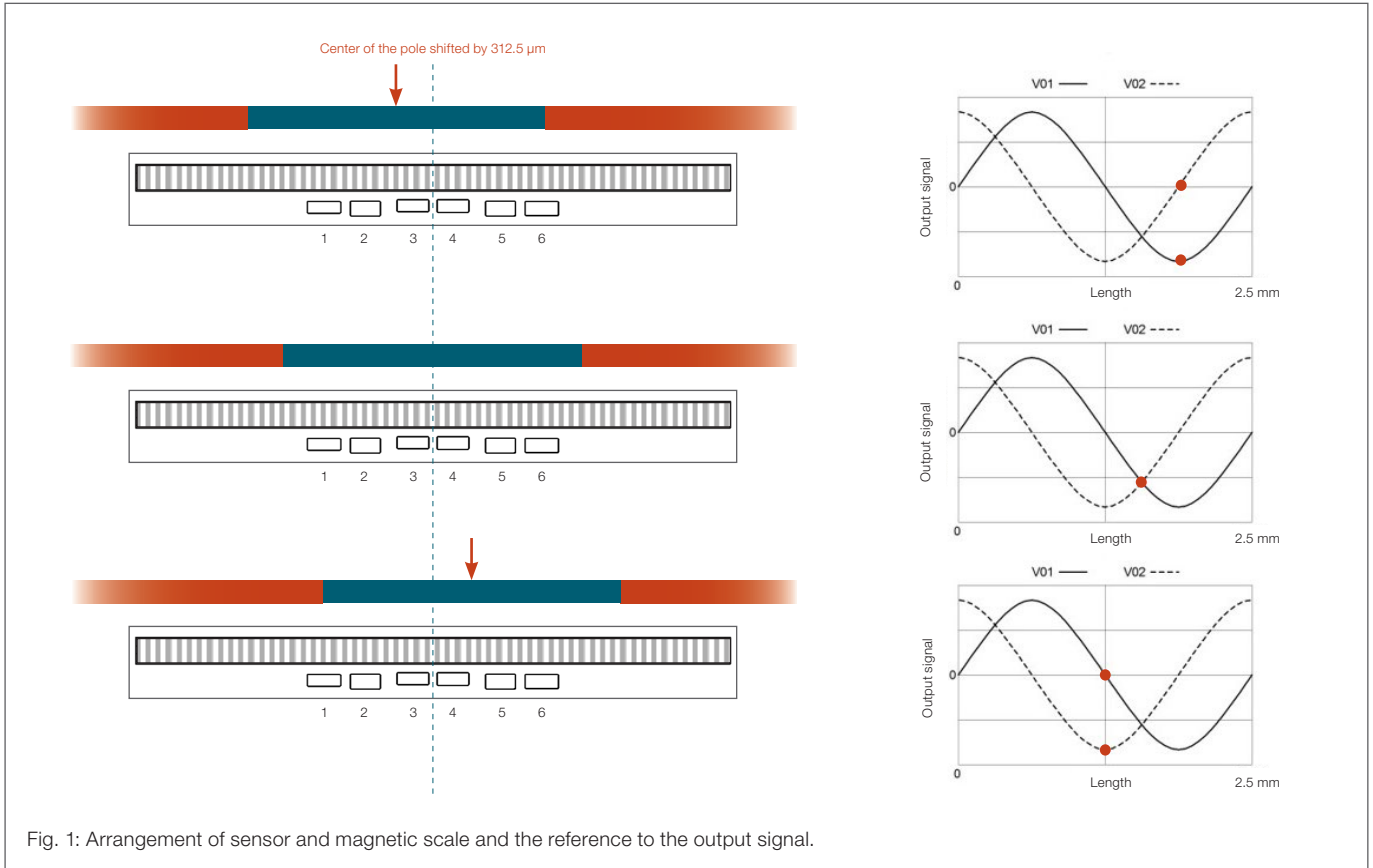
¹⁰⁾ No significant amplitude attenuation.

General Data

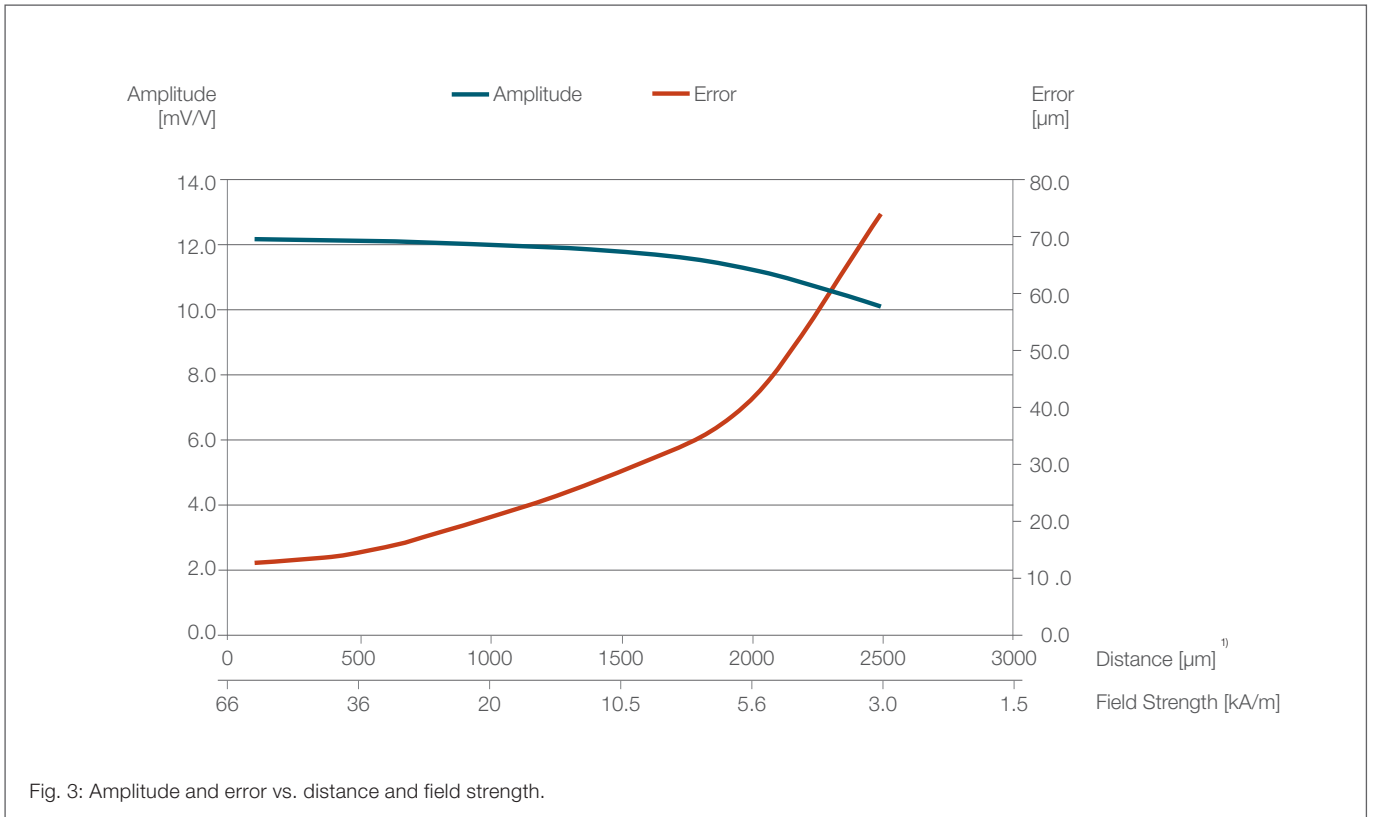
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
P	Pitch (magnetic pole length)	See Fig. 1	-	2.5	-	mm
d	Distance ¹¹⁾	See Fig. 1	-	1.0	-	mm
T_{amb}	Ambient temperature		-40	-	+125	°C

¹¹⁾ See Fig. 3 for detailed information.

Output Signal Information



Typical Performance Graphs



¹⁾ In use with a plastic bounded hard ferrite magnetic scale (Br = 220 mT, thickness 1 mm, mounted on stainless steel).

AL797 ACA Bare Die

Pinning

Pad	Symbol	Parameter
1	+V _{O1}	Positive output voltage bridge 1
2	+V _{O2}	Positive output voltage bridge 2
3	V _{CC}	Supply voltage
4	GND	Ground
5	-V _{O1}	Negative output voltage bridge 1
6	-V _{O2}	Negative output voltage bridge 2

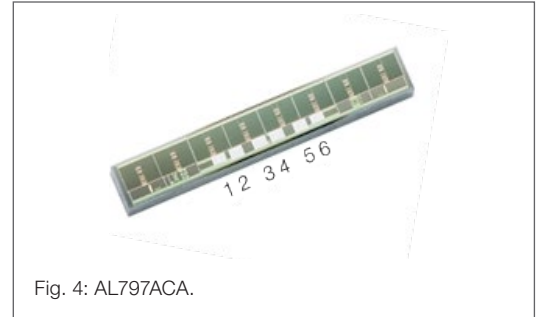


Fig. 4: AL797ACA.

Dimensions

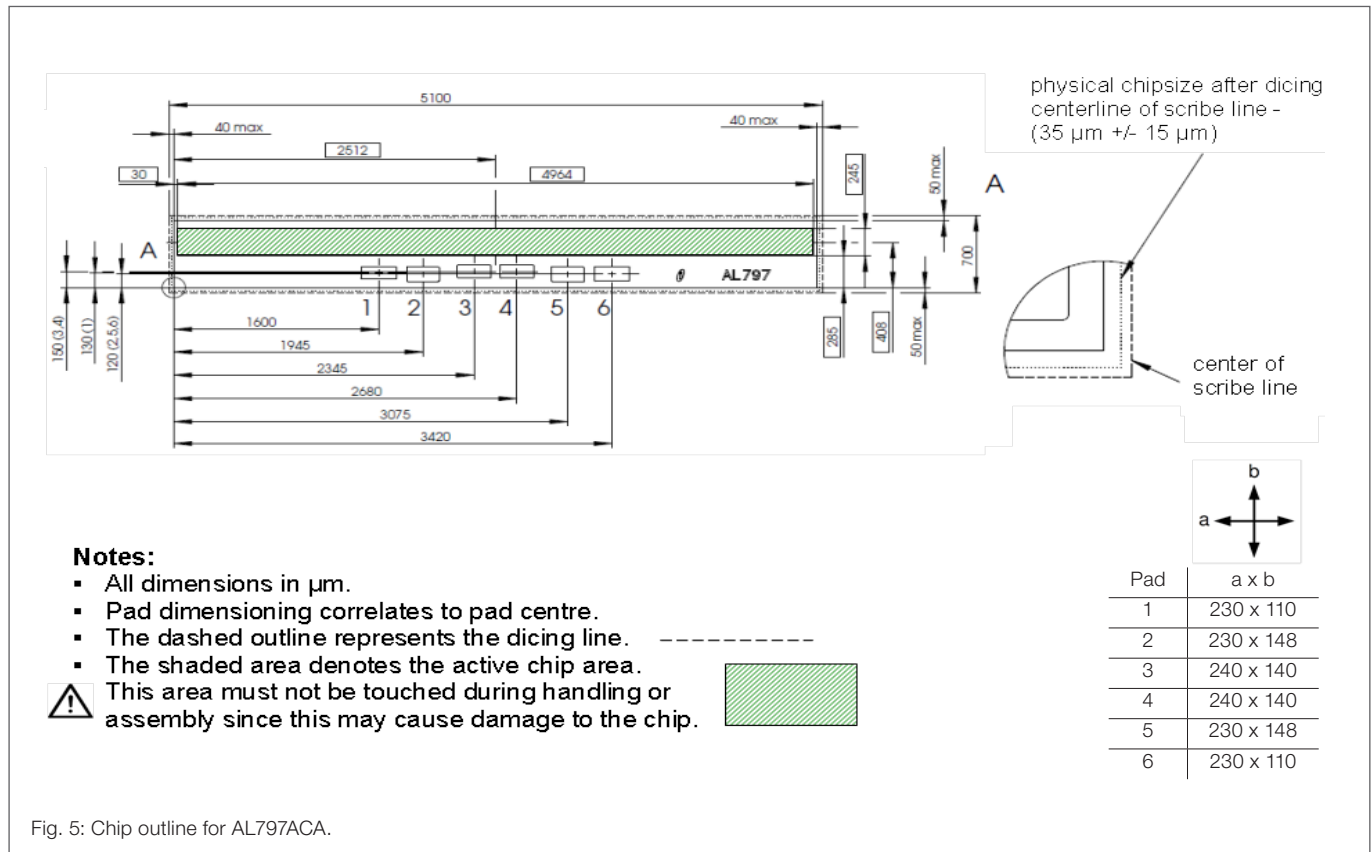


Fig. 5: Chip outline for AL797ACA.

Data for Packaging and Interconnection Technologies

Parameter	Value	Unit
Chip area ¹⁾	5.1 x 0.7	mm ²
Chip thickness	525 ± 10	μm
Pad size	See Fig. 5	-
Pad thickness	0.8	μm
Pad material	AlCu	-

¹⁾ Tolerances of chip size see Fig. 5.

AL797AKA SIL6 Package

Pinning

Pad	Symbol	Parameter
1	+V _{O1}	Positive output voltage bridge 1
2	+V _{O2}	Positive output voltage bridge 2
3	V _{CC}	Supply voltage
4	GND	Ground
5	-V _{O1}	Negative output voltage bridge 1
6	-V _{O2}	Negative output voltage bridge 2



Fig. 6: AL797AKA.

Dimensions

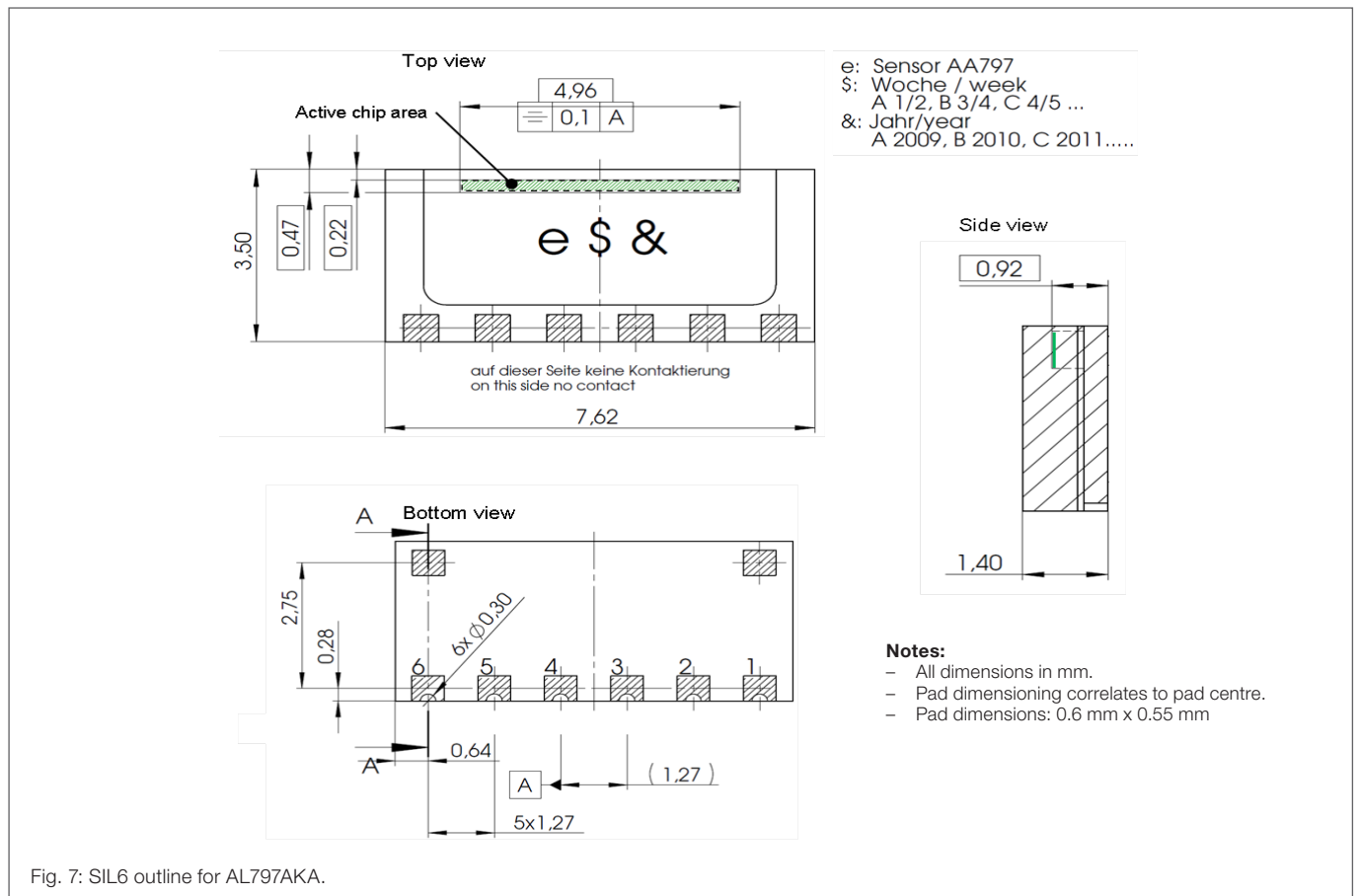


Fig. 7: SIL6 outline for AL797AKA.

AL797AMA LGA6L Package

Pinning

Pad	Symbol	Parameter
1	+V _{O1}	Positive output voltage bridge 1
2	+V _{O2}	Positive output voltage bridge 2
3	GND	Ground
4	V _{CC}	Supply voltage
5	-V _{O1}	Negative output voltage bridge 1
6	-V _{O2}	Negative output voltage bridge 2
7-10	NC	Not connected

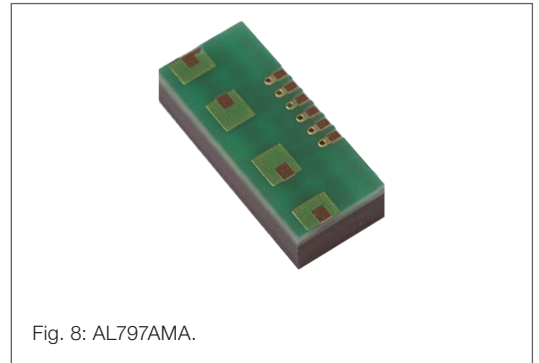


Fig. 8: AL797AMA.

Dimensions

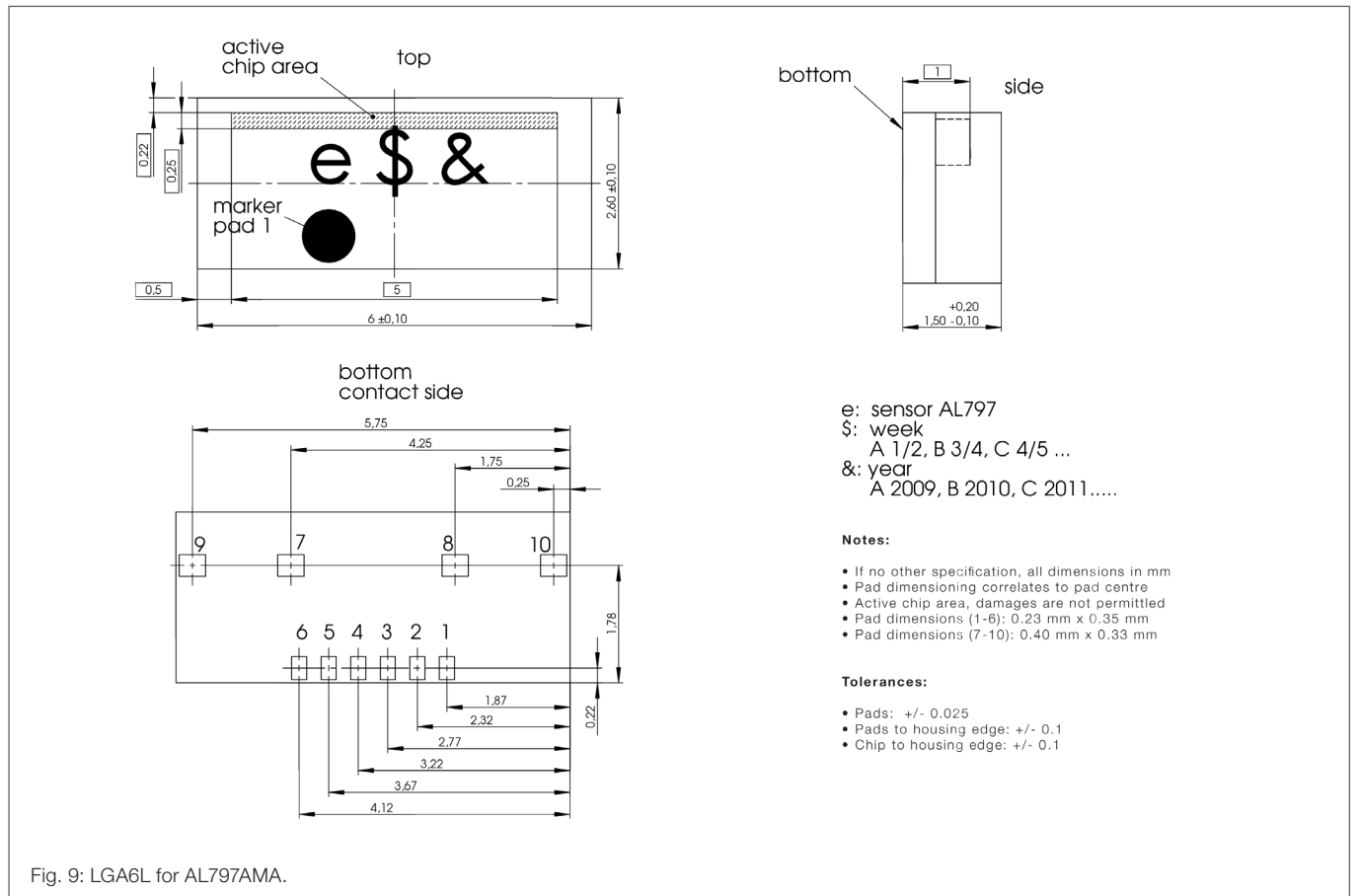


Fig. 9: LGA6L for AL797AMA.

Special Design Features

 **PerfectWave**

Sensors with PerfectWave design provide the best signal quality, highest accuracy and optimal sensor linearity by filtering out higher harmonics in the signal. The linearity of the sensor is assured, even for weak magnetic field measurement.

 **PurePitch**

In PurePitch sensors the FixPitch principle is extended over several poles in order to increase accuracy still further. This arrangement reduces the influence of errors in the measurement scale and improves the immunity to interference fields.

 **FixPitch**

FixPitch sensors are adapted to the pole length (pitch) of the measurement scale. The linearity of the sensor is optimized and the influence of interference fields is minimized.

General Information

Product Status

Article	Status
AL797ACA-AA	The product is in series production.
AL797ACA-AB	The product is in series production.
AL797AKA-AC	The product is in series production.
AL797AMA-AE	The product is in series production.
Note	The status of the product may have changed since this data sheet was published. The latest information is available on the internet at www.sensitec.com .

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Sensitec GmbH

Georg-Ohm-Str. 11 · 35633 Lahnau · Germany
Tel. +49 6441 9788-0 · Fax +49 6441 9788-17
www.sensitec.com · sensitec@sensitec.com

